

# Specification for Approval

**Date:** 2016/11/03

**Customer :** \_\_\_\_\_

**TAI-TECH P/N:** HPC(CF)-Series

**CUSTOMER P/N:** \_\_\_\_\_

**DESCRIPTION:** \_\_\_\_\_

**QUANTITY:** \_\_\_\_\_ pcs

<b>REMARK:</b>		
Customer Approval Feedback		

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APPROVED	CHECKED

R&D Center

APPROVED	CHECKED	DRAWN
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<b>SMD Power Inductor</b>	<b>HPC(CF)-Series</b>
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<b>ECN HISTORY LIST</b>					
REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN
1.0	16/01/08	新發行	楊祥忠	詹偉特	何秦芝
備註					

**SMD Power Inductor**

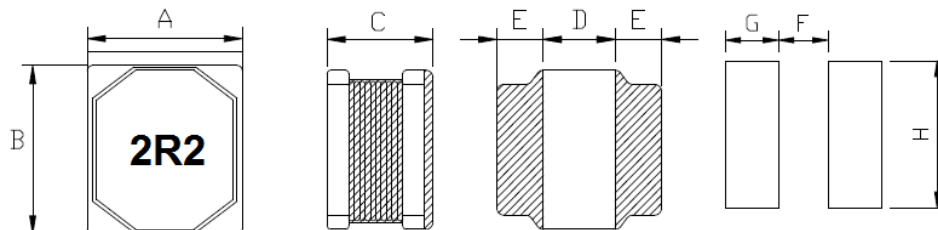
**HPC(CF)-Series**

**1. Features**

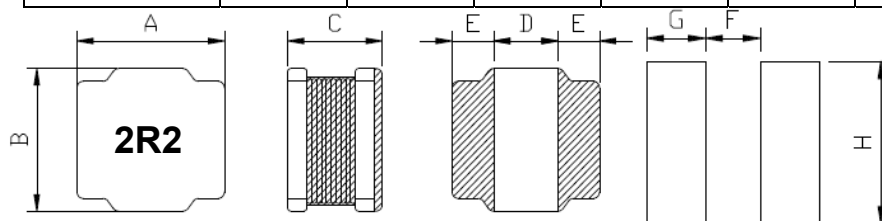
1. This specification applies Low Profile Power Inductors.
2. 100% Lead(Pb) & Halogen-Free and RoHS compliant.



**2. Dimension**

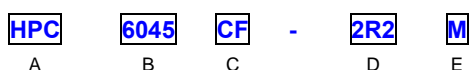


Series	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)	F(mm)	G(mm)	H(mm)
HPC4018CF	4.0±0.2	4.0±0.2	1.8Max	1.6±0.3	1.2±0.3	1.5	1.3	3.7
HPC4030CF	4.0±0.2	4.0±0.2	3.0Max	1.3±0.3	1.35±0.3	1.3	1.35	3.7
HPC5040CF	5.0±0.2	5.0±0.2	4.0Max	2.0±0.3	1.5±0.3	1.8	1.6	4.2
HPC6020CF	6.0±0.3	6.0±0.3	2.0Max	2.7±0.3	1.65±0.3	2.4	1.8	5.7



Series	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)	F(mm)	G(mm)	H(mm)
HPC5020CF	5.0±0.2	5.0±0.2	2.1Max	1.4±0.3	1.8±0.3	1.4	1.8	4.2
HPC6028CF	6.0±0.3	6.0±0.3	2.8Max	2.6±0.3	1.7±0.3	2.4	1.8	5.7
HPC6045CF	6.0±0.3	6.0±0.3	4.7Max	2.6±0.3	1.7±0.3	2.4	1.8	5.7
HPC8040CF	8.0±0.3	8.0±0.3	4.2Max	3.8±0.3	2.1±0.3	3.8	2.2	7.5

**3. Part Numbering**



- A: Series
  - B: Dimension
  - C: Type
  - D: Inductance
  - E: Inductance Tolerance
- A/B\*C
- 2R2=2.20uh 100=10uh,101=100uh,102=1000uh  
 M=±20%,Y=±30%.  
 marking Color: Black,

## 4. Specification

Part Number	Inductance L0 (uH) @ 0 A	Tolerance	DCR( $\Omega$ ) $\pm 30\%$ .	Isat(A) Max	Irms(A) Max	SRF (MHz) min
HPC4018CF-1R0Y	1.0	$\pm 30\%$	0.025	4.20	2.09	80
HPC4018CF-1R5Y	1.5	$\pm 30\%$	0.030	3.35	1.80	65
HPC4018CF-2R2M	2.2	$\pm 20\%$	0.045	2.70	1.65	52
HPC4018CF-3R3M	3.3	$\pm 20\%$	0.070	2.45	1.23	44
HPC4018CF-4R7M	4.7	$\pm 20\%$	0.090	1.70	1.20	34
HPC4018CF-6R8M	6.8	$\pm 20\%$	0.110	1.45	1.03	29
HPC4018CF-100M	10	$\pm 20\%$	0.180	1.30	0.84	24
HPC4018CF-150M	15	$\pm 20\%$	0.250	0.94	0.65	19
HPC4018CF-220M	22	$\pm 20\%$	0.360	0.80	0.59	16
HPC4018CF-330M	33	$\pm 20\%$	0.530	0.56	0.49	12
HPC4018CF-470M	47	$\pm 20\%$	0.650	0.57	0.42	10
HPC4018CF-680M	68	$\pm 20\%$	1.000	0.47	0.32	8.3
HPC4018CF-101M	100	$\pm 20\%$	1.750	0.40	0.25	6.5
HPC4018CF-151M	150	$\pm 20\%$	2.500	0.31	0.22	5.5
HPC4018CF-221M	220	$\pm 20\%$	4.000	0.27	0.17	4.0

Note:

- 1.All test data referenced to 25°C ambient , Ls:100KHz/1V.
- 2.Isat: DC current at which the inductance drops approximate 30% from its value without current;
- 3.Irms: DC current that causes the temperature rise ( $\Delta T = 40^\circ\text{C}$ ) from 25°C ambient.

Part Number	Inductance L0 (uH) @ 0 A	Tolerance	DCR( $\Omega$ ) $\pm 30\%$	Isat(A) Max	Irms(A) Max	SRF (MHz) min
HPC4030CF-1R0Y	1.0	$\pm 30\%$	0.016	5.26	4.15	70
HPC4030CF-1R2Y	1.2	$\pm 30\%$	0.018	5.8	3.82	80
HPC4030CF-1R5Y	1.5	$\pm 30\%$	0.020	4.84	3.34	62
HPC4030CF-1R8Y	1.8	$\pm 30\%$	0.028	4.80	3.00	60
HPC4030CF-2R2Y	2.2	$\pm 30\%$	0.030	4.40	2.95	52
HPC4030CF-3R3M	3.3	$\pm 20\%$	0.040	3.30	2.40	38
HPC4030CF-4R7M	4.7	$\pm 20\%$	0.060	2.90	2.00	31
HPC4030CF-5R6M	5.6	$\pm 20\%$	0.065	2.60	1.95	30
HPC4030CF-6R8M	6.8	$\pm 20\%$	0.090	2.75	1.60	24
HPC4030CF-8R2M	8.2	$\pm 20\%$	0.090	2.10	1.60	26
HPC4030CF-100M	10.0	$\pm 20\%$	0.100	1.95	1.50	21
HPC4030CF-120M	12.0	$\pm 20\%$	0.135	1.70	1.30	18
HPC4030CF-150M	15.0	$\pm 20\%$	0.190	1.65	1.11	16
HPC4030CF-180M	18.0	$\pm 20\%$	0.200	1.40	1.10	10
HPC4030CF-220M	22.0	$\pm 20\%$	0.225	1.30	1.00	10
HPC4030CF-330M	33.0	$\pm 20\%$	0.330	1.10	0.84	10
HPC4030CF-390M	39.0	$\pm 20\%$	0.435	1.03	0.73	10
HPC4030CF-470M	47.0	$\pm 20\%$	0.445	0.95	0.72	8.4
HPC4030CF-560M	56.0	$\pm 20\%$	0.555	0.85	0.65	8.4
HPC4030CF-680M	68.0	$\pm 20\%$	0.868	0.72	0.52	7
HPC4030CF-820M	82.0	$\pm 20\%$	1.060	0.66	0.47	5.6
HPC4030CF-101M	100	$\pm 20\%$	1.150	0.60	0.45	5.6
HPC4030CF-121M	120	$\pm 20\%$	1.350	0.55	0.42	5.4
HPC4030CF-151M	150	$\pm 20\%$	1.800	0.50	0.3	4
HPC4030CF-221M	220	$\pm 20\%$	2.500	0.40	0.35	4.2
HPC4030CF-331M	330	$\pm 20\%$	4.000	0.30	0.25	6.8
HPC4030CF-471M	470	$\pm 20\%$	7.200	0.30	0.20	2
HPC4030CF-681M	680	$\pm 20\%$	7.580	0.19	0.14	1.2

## Note:

1. All test data referenced to 25°C ambient, Ls:100KHz/1V.
2. Isat: DC current at which the inductance drops approximate 30% from its value without current;
3. Irms: DC current that causes the temperature rise ( $\Delta T = 40^\circ\text{C}$ ) from 25°C ambient.

Part Number	Inductance L0 (uH) @ 0 A	Tolerance	DCR( $\Omega$ ) $\pm 30\%$ .	Isat(A) Max	Irms(A) Max	SRF (MHz) min
HPC5020CF-1R0Y	1.0	$\pm 30\%$	0.020	4.10	3.80	114
HPC5020CF-1R5Y	1.5	$\pm 30\%$	0.030	4.10	3.20	68
HPC5020CF-2R2Y	2.2	$\pm 30\%$	0.040	3.20	2.70	57
HPC5020CF-3R3Y	3.3	$\pm 30\%$	0.050	2.55	2.30	46
HPC5020CF-4R7M	4.7	$\pm 20\%$	0.057	2.50	2.20	37
HPC5020CF-6R8M	6.8	$\pm 20\%$	0.083	2.05	1.80	30
HPC5020CF-8R2M	8.2	$\pm 20\%$	0.098	1.85	1.65	26
HPC5020CF-100M	10.0	$\pm 20\%$	0.120	1.70	1.55	24
HPC5020CF-120M	12.0	$\pm 20\%$	0.140	1.50	1.40	22
HPC5020CF-150M	15.0	$\pm 20\%$	0.165	1.35	1.25	20
HPC5020CF-180M	18.0	$\pm 20\%$	0.200	1.25	1.15	16
HPC5020CF-220M-	22.0	$\pm 20\%$	0.250	1.15	1.10	14
HPC5020CF-330M	33.0	$\pm 20\%$	0.400	0.92	0.90	10
HPC5020CF-470M	47.0	$\pm 20\%$	0.580	0.77	0.75	7
HPC5020CF-680M	68.0	$\pm 20\%$	0.740	0.65	0.64	6
HPC5020CF-820M	82.0	$\pm 20\%$	0.965	0.65	0.50	6
HPC5020CF-101M	100	$\pm 20\%$	1.100	0.53	0.40	6

## Note:

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- 3.Irms: DC current that causes the temperature rise ( $\Delta T = 40^\circ\text{C}$ ) from 25°C ambient.

Part Number	Inductance L0 (uH) @ 0 A	Tolerance	DCR( $\Omega$ ) $\pm 30\%$ .	Isat(A) Max	Irms(A) Max	SRF (MHz) min
HPC5040CF-1R0Y	1.0	$\pm 30\%$	0.012	7.35	4.90	117
HPC5040CF-1R2Y	1.2	$\pm 30\%$	0.016	6.50	4.15	110
HPC5040CF-1R5Y	1.5	$\pm 30\%$	0.018	6.30	4.00	86
HPC5040CF-2R2Y	2.2	$\pm 30\%$	0.019	4.90	3.80	50
HPC5040CF-2R7Y	2.7	$\pm 30\%$	0.022	4.30	3.60	37
HPC5040CF-3R3Y	3.3	$\pm 30\%$	0.024	3.95	3.40	32
HPC5040CF-3R9Y	3.9	$\pm 30\%$	0.027	3.55	3.20	29
HPC5040CF-4R7M	4.7	$\pm 20\%$	0.032	3.50	3.00	28
HPC5040CF-5R6M	5.6	$\pm 20\%$	0.035	3.00	2.80	27
HPC5040CF-6R8M	6.8	$\pm 20\%$	0.043	2.90	2.50	21
HPC5040CF-100M	10.0	$\pm 20\%$	0.064	2.35	2.10	18
HPC5040CF-150M	15.0	$\pm 20\%$	0.086	2.00	2.00	13
HPC5040CF-220M	22.0	$\pm 20\%$	0.129	1.60	1.50	11
HPC5040CF-330M	33.0	$\pm 20\%$	0.188	1.30	1.20	9.1
HPC5040CF-470M	47.0	$\pm 20\%$	0.272	1.10	1.00	6.7
HPC5040CF-680M	68.0	$\pm 20\%$	0.400	0.90	0.80	5.7
HPC5040CF-101M	100	$\pm 20\%$	0.560	0.75	0.70	4.7
HPC5040CF-151M	150	$\pm 20\%$	0.750	0.65	0.60	5
HPC5040CF-221M	220	$\pm 20\%$	1.280	0.40	0.38	3
HPC5040CF-102M	1000	$\pm 20\%$	6.200	0.25	0.25	2
HPC5040CF-222M	2200	$\pm 20\%$	13.000	0.10	0.10	2

## Note:

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- 2Isat: DC current at which the inductance drops approximate 30% from its value without current;
- 3.Irms: DC current that causes the temperature rise ( $\Delta T = 40^\circ C$ ) from 25°C ambient.

Part Number	Inductance L0 (uH) @ 0 A	Tolerance	DCR( $\Omega$ ) $\pm 30\%$ .	Isat(A) Max	Irms(A) Max	SRF (MHz) min
HPC6020CF-R50Y	0.50	$\pm 30\%$	0.014	4.50	3.30	120
HPC6020CF-R68Y	0.68	$\pm 30\%$	0.017	6.55	3.80	115
HPC6020CF-R82Y	0.82	$\pm 30\%$	0.017	5.30	3.80	110
HPC6020CF-1R0Y	1.0	$\pm 30\%$	0.020	4.15	3.50	100
HPC6020CF-1R2Y	1.2	$\pm 30\%$	0.022	5.90	3.20	88
HPC6020CF-1R5Y	1.5	$\pm 30\%$	0.022	4.25	3.20	79
HPC6020CF-1R8Y	1.8	$\pm 30\%$	0.028	4.85	2.75	68
HPC6020CF-2R2Y	2.2	$\pm 30\%$	0.028	3.75	2.75	61
HPC6020CF-2R7Y	2.7	$\pm 30\%$	0.035	3.90	2.60	56
HPC6020CF-3R3Y	3.3	$\pm 30\%$	0.035	3.15	2.60	51
HPC6020CF-3R9Y	3.9	$\pm 30\%$	0.049	3.25	2.10	45
HPC6020CF-4R7M	4.7	$\pm 20\%$	0.058	3.00	2.00	41
HPC6020CF-5R6M	5.6	$\pm 20\%$	0.058	2.40	1.90	36
HPC6020CF-6R8M	6.8	$\pm 20\%$	0.079	2.20	1.80	31
HPC6020CF-8R2M	8.2	$\pm 20\%$	0.105	2.10	1.40	27
HPC6020CF-100M	10.0	$\pm 20\%$	0.105	1.75	1.40	27
HPC6020CF-120M	12.0	$\pm 20\%$	0.120	1.45	1.30	25
HPC6020CF-150M	15.0	$\pm 20\%$	0.145	1.20	1.20	21
HPC6020CF-180M	18.0	$\pm 20\%$	0.180	1.20	1.08	18
HPC6020CF-220M	22.0	$\pm 20\%$	0.204	1.05	1.00	16
HPC6020CF-330M	33.0	$\pm 20\%$	0.300	0.95	0.84	11
HPC6020CF-470M	47.0	$\pm 20\%$	0.430	0.70	0.80	10

## Note:

- 1.All test data referenced to 25°C ambient , Ls:100KHz/1V.
- 2.Isat: DC current at which the inductance drops approximate 30% from its value without current;
- 3.Irms: DC current that causes the temperature rise ( $\Delta T = 40^\circ\text{C}$ ) from 25°C ambient.



Part Number	Inductance L0 (uH) @ 0 A	Tolerance	DCR( $\Omega$ ) $\pm 30\%$ .	Isat(A) Max	Irms(A) Max
HPC6028CF-1R0Y	1.00	$\pm 30\%$	0.012	5.75	5.20
HP6028CF-1R5Y	1.50	$\pm 30\%$	0.015	6.00	4.58
HP6028CF-2R2Y	2.20	$\pm 30\%$	0.020	5.10	3.75
HP6028CF-2R7Y	2.70	$\pm 30\%$	0.020	3.80	3.75
HP6028CF-3R3Y	3.30	$\pm 30\%$	0.025	4.15	3.48
HP6028CF-4R7M	4.70	$\pm 20\%$	0.030	3.00	3.08
HP6028CF-5R1M	5.10	$\pm 20\%$	0.043	3.20	2.60
HP6028CF-6R2M	6.20	$\pm 20\%$	0.047	3.05	2.40
HP6028CF-6R8M	6.80	$\pm 20\%$	0.047	2.60	2.40
HP6028CF-8R2M	8.2	$\pm 20\%$	0.055	2.30	2.25
HP6028CF-9R1M	9.10	$\pm 20\%$	0.074	2.55	2.15
HP6028CF-100M	10.0	$\pm 20\%$	0.072	2.04	1.95
HP6028CF-120M	12.0	$\pm 20\%$	0.080	1.80	1.85
HP6028CF-150M	15.0	$\pm 20\%$	0.125	1.75	1.45
HP6028CF-180M	18.0	$\pm 20\%$	0.120	1.52	1.45
HP6028CF-220M	22.0	$\pm 20\%$	0.140	1.45	1.40
HP6028CF-270M	27.0	$\pm 20\%$	0.155	1.50	1.32
HP6028CF-330M	33.0	$\pm 20\%$	0.185	1.35	1.22
HP6028CF-360M	36.0	$\pm 20\%$	0.215	1.25	1.13
HP6028CF-390M	39.0	$\pm 20\%$	0.225	1.25	1.10
HP6028CF-470M	47.0	$\pm 20\%$	0.315	1.15	1.06
HP6028CF-680M	68.0	$\pm 20\%$	0.360	0.80	0.86
HP6028CF-750M	75.0	$\pm 20\%$	0.410	0.90	0.81
HP6028CF-820M	82.0	$\pm 20\%$	0.500	0.80	0.70
HP6028CF-101M	100.0	$\pm 20\%$	0.500	0.65	0.70
HP6028CF-102M	1000.0	$\pm 20\%$	5.800	0.18	0.20

## Note:

1. All test data referenced to 25°C ambient, Ls:100KHz/1V.
2. Isat: DC current at which the inductance drops approximate 30% from its value without current;
3. Irms: DC current that causes the temperature rise ( $\Delta T = 40^\circ\text{C}$ ) from 25°C ambient.

Part Number	Inductance L0 (uH) @ 0 A	Tolerance	DCR( $\Omega$ ) $\pm 30\%$ .	Isat(A) Max	Irms(A) Max	SRF(MHz) min
HPC6045CF-R82Y	0.82	$\pm 30\%$	0.008	10.35	5.90	140
HPC6045CF-1R0Y	1.00	$\pm 30\%$	0.011	9.85	5.14	100
HPC6045CF-1R2Y	1.20	$\pm 30\%$	0.010	8.35	5.40	100
HPC6045CF-1R5Y	1.50	$\pm 30\%$	0.012	8.80	4.95	65
HPC6045CF-1R8Y	1.80	$\pm 30\%$	0.012	7.60	4.95	74
HPC6045CF-2R2Y	2.20	$\pm 30\%$	0.014	6.75	4.60	52
HPC6045CF-3R3Y	3.30	$\pm 30\%$	0.024	5.90	3.70	32
HPC6045CF-4R7M	4.70	$\pm 20\%$	0.031	4.97	3.30	24
HPC6045CF-5R6M	5.60	$\pm 20\%$	0.034	4.15	3.15	23
HPC6045CF-6R8M	6.80	$\pm 20\%$	0.031	3.90	3.00	20
HPC6045CF-8R2M	8.20	$\pm 20\%$	0.043	3.90	2.60	21
HPC6045CF-100M	10.0	$\pm 20\%$	0.048	3.20	2.45	15
HPC6045CF-120M	12.0	$\pm 20\%$	0.058	2.80	2.20	13
HPC6045CF-150M	15.0	$\pm 20\%$	0.068	2.50	2.05	12
HPC6045CF-180M	18.0	$\pm 20\%$	0.081	2.20	1.85	10
HPC6045CF-220M	22.0	$\pm 20\%$	0.089	2.05	1.80	10
HPC6045CF-270M	27.0	$\pm 20\%$	0.102	1.90	1.65	9.2
HPC6045CF-330M	33.0	$\pm 20\%$	0.137	1.65	1.45	7.8
HPC6045CF-390M	39.0	$\pm 20\%$	0.180	1.50	1.25	7.8
HPC6045CF-470M	47.0	$\pm 20\%$	0.200	1.40	1.20	6.4
HPC6045CF-510M	51.0	$\pm 20\%$	0.207	1.35	1.15	6.4
HPC6045CF-560M	56.0	$\pm 20\%$	0.221	1.30	1.10	6.4
HPC6045CF-620M	62.0	$\pm 20\%$	0.235	1.25	1.10	6.4
HPC6045CF-680M	68.0	$\pm 20\%$	0.289	1.20	1.00	6.4
HPC6045CF-750M	75.0	$\pm 20\%$	0.305	1.15	0.95	5.0
HPC6045CF-820M	82.0	$\pm 20\%$	0.341	1.05	0.90	4.9
HPC6045CF-910M	91.0	$\pm 20\%$	0.359	1.00	0.85	4.9
HPC6045CF-101M	100	$\pm 20\%$	0.433	0.95	0.80	4.2
HPC6045CF-121M	120	$\pm 20\%$	0.484	0.85	0.77	4.2
HPC6045CF-151M	150	$\pm 20\%$	0.580	0.80	0.70	4.2
HPC6045CF-221M	220	$\pm 20\%$	0.834	0.70	0.59	3.5
HPC6045CF-331M	330	$\pm 20\%$	1.270	0.57	0.57	2.8
HPC6045CF-471M	470	$\pm 20\%$	1.800	0.50	0.42	2
HPC6045CF-681M	680	$\pm 20\%$	2.500	0.42	0.33	1.7
HPC6045CF-102M	1000	$\pm 20\%$	4.500	0.30	0.30	1.4
HPC6045CF-152M	1500	$\pm 20\%$	6.500	0.24	0.21	0.8

## Note:

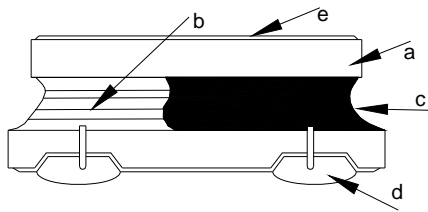
- 1.All test data referenced to 25°C ambient , Ls:100KHz/1V.
- 2.Isat: DC current at which the inductance drops approximate 30% from its value without current;
- 3.Irms: DC current that causes the temperature rise ( $\Delta T = 40^\circ\text{C}$ ) from 25°C ambient.

Part Number	Inductance L0 (uH) @ 0 A	Tolerance	DCR( $\Omega$ ) $\pm 30\%$ .	Isat(A) Max	Irms(A) Max	SRF(MHz) min
HPC8040CF-R82Y	0.82	$\pm 30\%$	0.008	13.80	6.30	94
HPC8040CF-1R0Y	1.00	$\pm 30\%$	0.008	9.85	6.30	89
HPC8040CF-1R5Y	1.50	$\pm 30\%$	0.010	8.15	5.65	67
HPC8040CF-2R2Y	2.20	$\pm 30\%$	0.012	7.10	5.15	41
HPC8040CF-3R3M	3.30	$\pm 20\%$	0.017	6.50	4.40	27
HPC8040CF-4R7M	4.70	$\pm 20\%$	0.019	5.90	4.10	24
HPC8040CF-6R8M	6.80	$\pm 20\%$	0.024	4.55	3.60	20
HPC8040CF-8R2M	8.20	$\pm 20\%$	0.026	4.20	3.45	17
HPC8040CF-100M	10.0	$\pm 20\%$	0.042	3.60	3.30	15
HPC8040CF-150M	15.0	$\pm 20\%$	0.047	2.95	2.60	12
HPC8040CF-180M	18.0	$\pm 20\%$	0.053	2.70	2.40	11
HPC8040CF-220M	22.0	$\pm 20\%$	0.069	2.40	2.10	9.5
HPC8040CF-330M	33.0	$\pm 20\%$	0.097	2.05	1.80	7.8
HPC8040CF-390M	39.0	$\pm 20\%$	0.107	1.95	1.70	7.8
HPC8040CF-470M	47.0	$\pm 20\%$	0.136	1.75	1.55	6.4
HPC8040CF-560M	56.0	$\pm 20\%$	0.148	1.55	1.45	6.4
HPC8040CF-680M	68.0	$\pm 20\%$	0.196	1.45	1.25	4.9
HPC8040CF-820M	82.0	$\pm 20\%$	0.225	1.30	1.15	5.9
HPC8040CF-910M	91.0	$\pm 20\%$	0.272	1.20	1.05	4.9
HPC8040CF-101M	100	$\pm 20\%$	0.290	1.15	1.00	4.2
HPC8040CF-121M	120	$\pm 20\%$	0.334	1.05	0.95	3.5
HPC8040CF-151M	150	$\pm 20\%$	0.410	1.10	0.85	3.5
HPC8040CF-221M	220	$\pm 20\%$	0.599	0.85	0.80	3.5
HPC8040CF-331M	330	$\pm 20\%$	0.889	0.68	0.64	2.8

## Note:

- 1.All test data referenced to 25°C ambient , Ls:100KHz/1V.
- 2.Isat: DC current at which the inductance drops approximate 30% from its value without current;
- 3.Irms: DC current that causes the temperature rise ( $\Delta T = 40^\circ\text{C}$ ) from 25°C ambient.

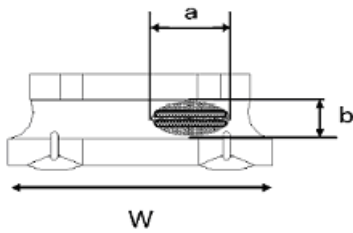
**5. Material List**



NO	Items	Materials
a	Core	Ferrite Core
b	Wire	Copper Wire
c	Glue	Epoxy with magnetic
d	Solder	Ag/Ni/Sn
e	ink	Halogen-free ketone

**Void appearance tolerance Limit**

Size of voids occurring to coating resin is specified below.

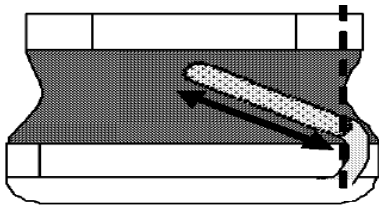


Appearance of exposed wire tolerance limit :

1. Width direction ( dimension a ) : Acceptable when  $a \leq w/2$   
Nonconforming when  $a > w/2$
2. Length direction ( dimension b ) : Dimension b is not specified.
3. The total area of exposed wire occurring to each sides is not greater than 50% of coating resin area, and is acceptable.

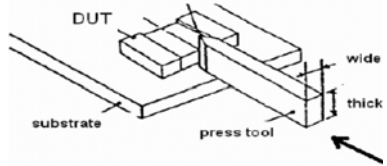
**External appearance criterion for exposed wire**

Exposed end of the winding wire at the secondary side should be 2mm and below.



## 6. Reliability and Test Condition

Item	Performance	Test Condition
Operating temperature	-40~+125°C (Including self - temperature rise)	
Storage temperature	-40~+125°C (on board)	
<b>Electrical Performance Test</b>		
Inductance	Refer to standard electrical characteristics list.	HP4284A,CH11025,CH3302,CH1320,CH1320S LCR Meter.
DCR		CH16502,Agilent33420A Micro-Ohm Meter.
Saturation Current (Isat)	Approximately $\Delta L30\%$	Saturation DC Current (Isat) will cause L0 to drop $\Delta L(\%)$
Heat Rated Current (Irms)	$\Delta T40^{\circ}\text{C}$	Heat Rated Current (Irms) will cause the coil temperature rise $\Delta T(^{\circ}\text{C})$ without core loss. 1. Applied the allowed DC current. 2. Temperature measured by digital surface thermometer
<b>Reliability Test</b>		
Life Test	Appearance : No damage. Inductance : within $\pm 10\%$ of initial value Q : Shall not exceed the specification value. RDC : within $\pm 15\%$ of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles) Temperature : 125 $\pm 2^{\circ}\text{C}$ (Inductor) Applied current : rated current Duration : 1000 $\pm 12$ hrs Measured at room temperature after placing for 24 $\pm 2$ hrs
Load Humidity		Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles) Humidity : 85 $\pm 2\%$ R.H, Temperature : 85 $\pm 2^{\circ}\text{C}$ Duration : 1000hrs Min. with 100% rated current Measured at room temperature after placing for 24 $\pm 2$ hrs
Moisture Resistance		Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles) 1. Baked at 50 $\pm 2^{\circ}\text{C}$ for 25hrs, measured at room temperature after placing for 4 hrs. 2. Raise temperature to 65 $\pm 2^{\circ}\text{C}$ 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25 $\pm 2^{\circ}\text{C}$ in 2.5hrs. 3. Raise temperature to 65 $\pm 2^{\circ}\text{C}$ 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25 $\pm 2^{\circ}\text{C}$ in 2.5hrs,keep at 25 $\pm 2^{\circ}\text{C}$ for 2 hrs then keep at -10 $\pm 2^{\circ}\text{C}$ for 3 hrs 4. Keep at 25 $\pm 2^{\circ}\text{C}$ 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.
Thermal shock		Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles) Condition for 1 cycle Step1 : -40 $\pm 2^{\circ}\text{C}$ 30 $\pm 5$ min Step2 : 25 $\pm 2^{\circ}\text{C}$ $\leq 0.5$ min Step3 : 125 $\pm 2^{\circ}\text{C}$ 30 $\pm 5$ min Number of cycles : 500 Measured at room temperature after placing for 24 $\pm 2$ hrs
Vibration		Oscillation Frequency: 10 ~ 2K ~ 10Hz for 20 minutes Equipment : Vibration checker Total Amplitude:1.52mm $\pm 10\%$ Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations).

Item	Performance	Test Condition															
Shock	Appearance : No damage. Inductance : within±10% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value	<table border="1"> <thead> <tr> <th>Type</th> <th>Peak value (g's)</th> <th>Normal duration (D) (ms)</th> <th>Wave form</th> <th>Velocity change (Vi)ft/sec</th> </tr> </thead> <tbody> <tr> <td>SMD</td> <td>50</td> <td>11</td> <td>Half-sine</td> <td>11.3</td> </tr> <tr> <td>Lead</td> <td>50</td> <td>11</td> <td>Half-sine</td> <td>11.3</td> </tr> </tbody> </table>	Type	Peak value (g's)	Normal duration (D) (ms)	Wave form	Velocity change (Vi)ft/sec	SMD	50	11	Half-sine	11.3	Lead	50	11	Half-sine	11.3
Type	Peak value (g's)	Normal duration (D) (ms)	Wave form	Velocity change (Vi)ft/sec													
SMD	50	11	Half-sine	11.3													
Lead	50	11	Half-sine	11.3													
Bending		Shall be mounted on a FR4 substrate of the following dimensions: >=0805:40x100x1.2mm <0805:40x100x0.8mm Bending depth: >=0805:1.2mm <0805:0.8mm duration of 10 sec.															
Solderability	More than 95% of the terminal electrode should be covered with solder.	Preheat: 150°C,60sec. Solder: Sn96.5% Ag3% Cu0.5% Temperature: 245±5°C Flux for lead free: Rosin. 9.5%. Dip time: 4±1sec. Depth: completely cover the termination															
Resistance to Soldering Heat		Number of heat cycles: 1  <table border="1"> <thead> <tr> <th>Temperature (°C)</th> <th>Time(s)</th> <th>Temperature ramp/immersion</th> </tr> </thead> <tbody> <tr> <td>260 ±5(solder temp)</td> <td>10 ±1</td> <td>25mm/s ±6 mm/s</td> </tr> </tbody> </table>	Temperature (°C)	Time(s)	Temperature ramp/immersion	260 ±5(solder temp)	10 ±1	25mm/s ±6 mm/s									
Temperature (°C)	Time(s)	Temperature ramp/immersion															
260 ±5(solder temp)	10 ±1	25mm/s ±6 mm/s															
Terminal Strength	Appearance : No damage. Inductance : within±10% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles With the component mounted on a PCB with the device to be tested, apply a force (>0805:1kg , <=0805:0.5kg)to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.  															

## 7. Soldering and Mounting

### (1) Soldering

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

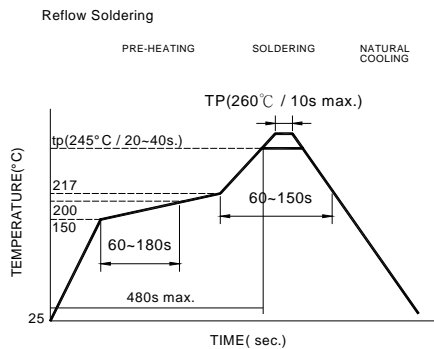
### (2) Solder re-flow:

Recommended temperature profiles for re-flow soldering in Figure 1.

### (3) Soldering Iron:

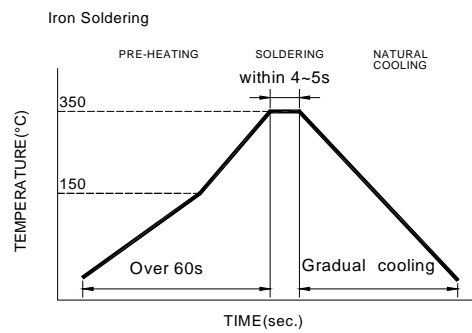
Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

- Preheat circuit and products to 150°C
- Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- 355°C tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 4-5sec.



Reflow times: 3 times max.

Fig.1

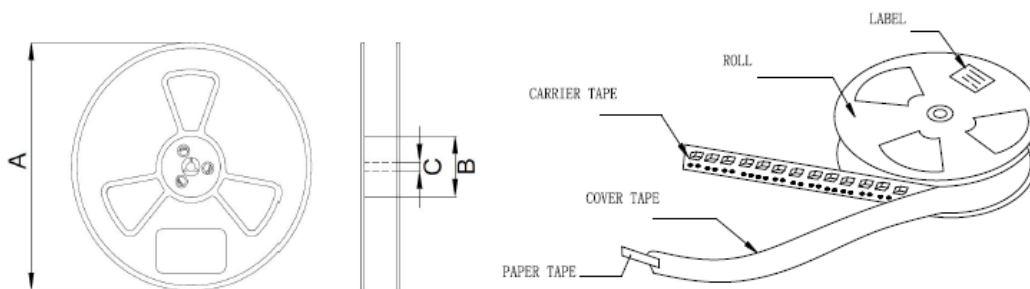


Iron Soldering times: 1 times max.

Fig.2

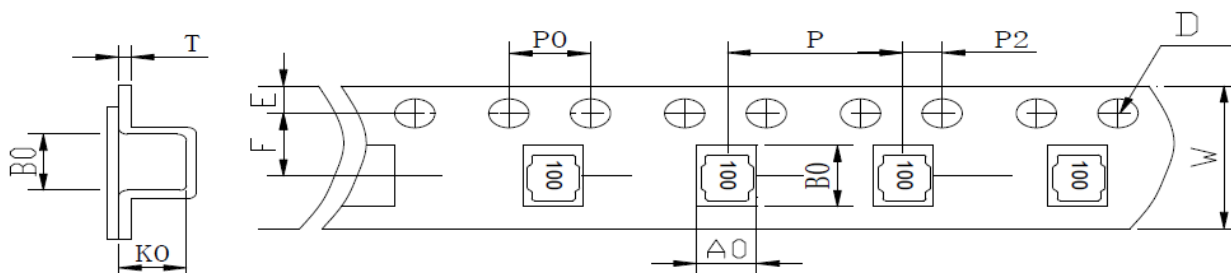
## 8. Packaging Information

### (1) Reel Dimension



Type	A(mm)	B(mm)	C(mm)
HPC4018	330	100	13
HPC4030	330	100	13
HPC5020	330	100	13
HPC5040	330	100	13
HPC6020	330	100	13
HPC6028	330	100	13
HPC6045	330	100	13
HPC8040	330	100	13

### (2) Tape Dimension

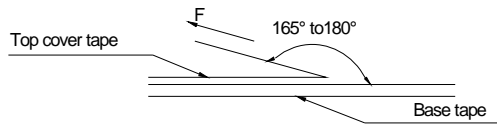


Series	Size	W(mm)	Ao(mm)	Bo(mm)	Ko(mm)	D(mm)	F(mm)	E(mm)	P (mm)	P0(mm)	P2(mm)	T(mm)
HPC	4018	12.0	4.3	4.3	2.2	1.5	5.5	1.75	8.0	4.0	2.0	0.3
HPC	4030	12.0	4.3	4.3	3.4	1.5	5.5	1.75	8.0	4.0	2.0	0.3
HPC	5020	12.0	5.4	5.4	2.4	1.5	5.5	1.75	8.0	4.0	2.0	0.3
HPC	5040	12.0	5.4	5.4	4.4	1.5	5.5	1.75	8.0	4.0	2.0	0.3
HPC	6020	16.0	6.4	6.4	2.4	1.5	7.5	1.75	8.0	4.0	2.0	0.35
HPC	6028	16.0	6.4	6.4	3.2	1.5	7.5	1.75	8.0	4.0	2.0	0.35
HPC	6045	16.0	6.4	6.4	4.8	1.5	7.5	1.75	8.0	4.0	2.0	0.35
HPC	8040	16.0	8.4	8.4	4.4	1.5	7.5	1.75	12.0	4.0	2.0	0.35

### (3) Packaging Quantity

HPC	4018	4030	5020	5040	6020	6028	6045	8040
PCS/Reel	3000	2000	2000	1500	2500	2000	1500	1000



**(4) Tearing Off Force**

The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions(referenced ANSI/EIA-481-C-2003 of 4.11 standard).

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min
5~35	45~85	860~1060	300

**Application Notice**

- Storage Conditions (component level)
  - To maintain the solderability of terminal electrodes:
    1. TAI-TECH products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
    2. Temperature and humidity conditions: Less than 40°C and 60% RH.
    3. Recommended products should be used within 12 months form the time of delivery.
    4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
  1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
  2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
  3. Bulk handling should ensure that abrasion and mechanical shock are minimized.